IPC ASSOCIATION CONNECTIN	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
upplier Inforn	nation														
Company name*			Company unique ID			Ţ	Unique ID Authority				Response Date*				
nsemi											2024-04-16				
Contact Name		Tit	Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Stew	ards	Pro	Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
uthorized Represe	entative*	Tit	Title - Representative			I	Phone - Representative*				Email - Representative*				
Product-Env-Stewa	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com						
Request	Requester Item Number Mfr Iter		em Number Mfr Item Name				Effective Date	Versio	on I	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP45540IMNTWG- H		WG-H		2024-04-16		ı	UTH		28.22	mg	Each		
Ianufacturing	Proccess Information	n													
Terminal Plating / Grid Array Material Termin			rminal Base Alloy J-STD-020 MSI			SL Rating	Peak Process Body Temperature Max Time at Peak			Temperat	ure Numb	per of Reflow Cyc	eles		
Matte Tin (Sn) - annealed		CU A	CU Alloy 3		3		260		С	30	secon	ds 3			
omments															
TTENTION: MS	L 3 Rated item requires Ba	ake and Dry P	Pack (after	electrical test)											
or more informati	on regarding material con	nposition plea	ase refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appl										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.29	mg	Supplier	Silicon (Si)	7440-21-3		1.29	mg
Die Attach	0.12	mg		Epoxy resin	proprietary data		0.003	mg
			Supplier	Silver (Ag)	7440-22-4		0.1014	mg
			Supplier	Phenolic Resin	Proprietary Data		0.003	mg
			Supplier	Inorganic filler	Proprietary Data		0.003	mg
			Supplier	Dicyandiamine	461-58-5		0.0006	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.009	mg
Lead Frame	12.38	mg	Supplier	Silver (Ag)	7440-22-4		0.2476	mg
			Supplier	Tin (Sn)	7440-31-5		0.031	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0272	mg
			Supplier	Chromium (Cr)	7440-47-3		0.031	mg
			Supplier	Copper (Cu)	7440-50-8		12.0433	mg
Mold Compound-Black	13.55	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		1.084	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0677	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.271	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.7207	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.4065	mg
Plating	0.44	mg	Supplier	Tin (Sn)	7440-31-5		0.44	mg
Wire Bond - Au	0.44	mg	Supplier	Gold (Au)	7440-57-5		0.44	mg